# International **10** Rectifier

# POWER MOSFET THRU-HOLE (TO-257AA)

#### **Product Summary**

Part Number	RDS(on)	ID	Eyelets	
IRFY140	0.077 Ω	16*A	Glass	
IRFY140M	0.077 Ω	16*A	Glass	

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

## Absolute Maximum Ratings

# IRFY140,IRFY140M 100V, N-CHANNEL HEXFET<sup>®</sup> MOSFET TECHNOLOGY



#### Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Glass Eyelets
- For Space Level Applications Refer to Ceramic Version Part Numbers IRFY140C, IRFY140CM

	Parameter		Units	
$I_D @ V_{GS} = 10V, T_C = 25^{\circ}C$	Continuous Drain Current	16*		
$I_D @ V_{GS} = 10V, T_C = 100^{\circ}C$	Continuous Drain Current	16*	A	
IDM	Pulsed Drain Current ①	64		
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	100	W	
	Linear Derating Factor	0.8	W/°C	
VGS	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy 2	230	mJ	
IAR	Avalanche Current ①	16*	А	
EAR	Repetitive Avalanche Energy ①	10	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	5.5	V/ns	
TJ	Operating Junction	-55 to 150		
TSTG Storage Temperature Range			°C	
	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)		
	Weight	3.3 (Typical)	g	

\* Current is limited by pin diameter For footnotes refer to the last page

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	100	—	—	V	VGS = 0V, ID = 1.0mA
∆BV <sub>DSS</sub> /∆T <sub>J</sub>	Temperature Coefficient of Breakdown Voltage	_	0.1	_	V/°C	Reference to 25°C, $I_D = 1.0$ mA
RDS(on)	Static Drain-to-Source On-State Resistance	—	_	0.077	Ω	VGS = 10V, ID = 16A ④
VGS(th)	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
9fs	Forward Transconductance	9.1	—	—	S(7)	V <sub>DS</sub> > 15V, I <sub>DS</sub> = 16A ④
IDSS	Zero Gate Voltage Drain Current	_	—	25		VDS= 80V ,VGS=0V
		_	_	250	μA	V <sub>DS</sub> = 80V,
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	_	—	100		VGS = 20V
IGSS	Gate-to-Source Leakage Reverse	_	—	-100	nA	VGS = -20V
Qg	Total Gate Charge	_	—	59		VGS =10V, ID = 16A
Qgs	Gate-to-Source Charge	_	—	12	nC	$V_{DS} = 50V$
Qgd	Gate-to-Drain ('Miller') Charge	_	—	30.7		
<sup>t</sup> d(on)	Turn-On Delay Time		—	21		V <sub>DD</sub> = 50V, I <sub>D</sub> = 16A,
tr	Rise Time	_	—	145		RG = 9.1Ω
td(off)	Turn-Off Delay Time		—	64	ns	
tf	Fall Time		—	105		
Ls+LD	Total Inductance	_	6.8	—	nH	Measured from drain lead (6mm/0.25in. from
						package) to source lead (6mm/0.25in. from package)
C <sub>iss</sub>	Input Capacitance	_	1660	_		$V_{GS} = 0V, V_{DS} = 25V$
C <sub>OSS</sub>	Output Capacitance	_	550	—	pF	f = 1.0MHz
C <sub>rss</sub>	Reverse Transfer Capacitance	—	120	—		

#### **Source-Drain Diode Ratings and Characteristics**

	Parameter		Тур	Max	Units	Test Conditions
IS	Continuous Source Current (Body Diode)	_	—	16	٨	
ISM	Pulse Source Current (Body Diode) ①	—	—	100	A	
VSD	Diode Forward Voltage	—	—	1.5	V	Tj = 25°C, IS = 16A, VGS = 0V ④
trr	Reverse Recovery Time		—	400	nS	Tj = 25°C, IF = 16A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge	_	—	2.4	μC	V <sub>DD</sub> ≤ 50V ④
ton	Forward Turn-On Time Intrinsic turn-on	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_{\text{S}}$ + $L_{\text{D}}$ .				

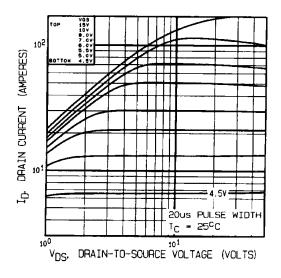
### **Thermal Resistance**

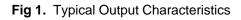
	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	_	—	1.25		
RthCS	Case-to-sink	—	0.21	—	°C/W	
R <sub>th</sub> JA	Junction-to-Ambient	—	—	80		Typical socket mount

Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page

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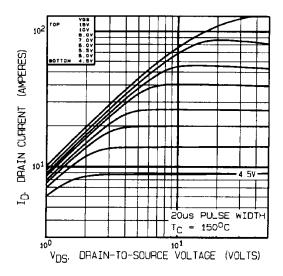


Fig 2. Typical Output Characteristics

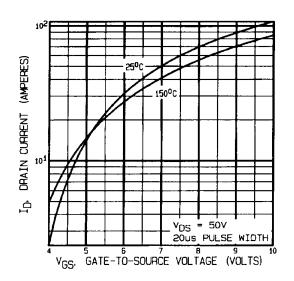
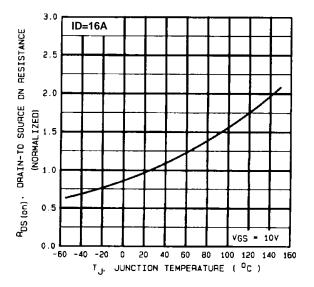
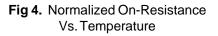


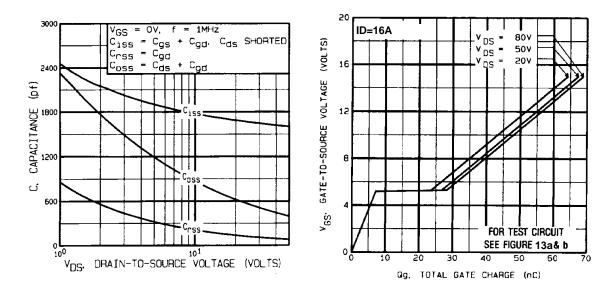
Fig 3. Typical Transfer Characteristics





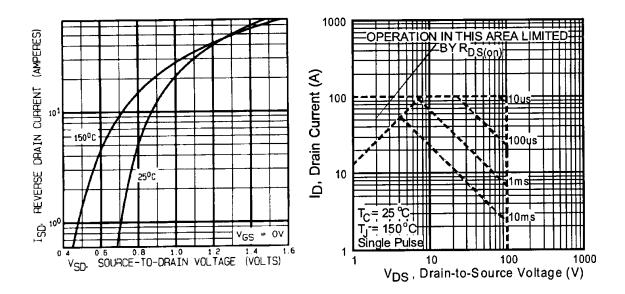
#### **IRFY140, IRFY140M**

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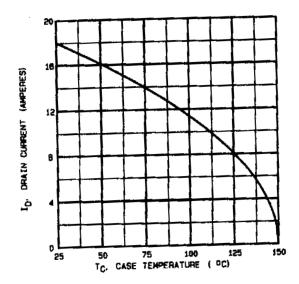


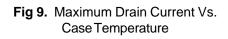


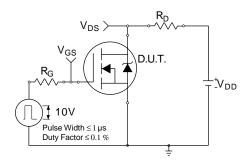


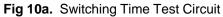
#### IRFY140, IRFY140M

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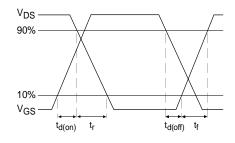


Fig 10b. Switching Time Waveforms

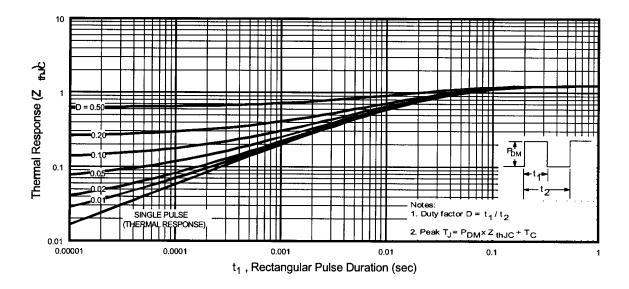


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

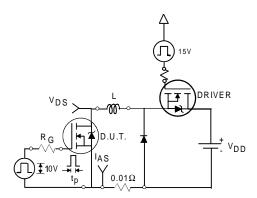


Fig 12a. Unclamped Inductive Test Circuit

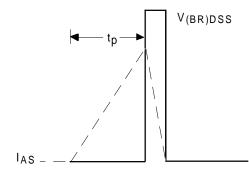


Fig 12b. Unclamped Inductive Waveforms

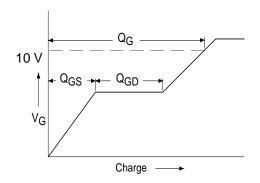


Fig 13a. Basic Gate Charge Waveform

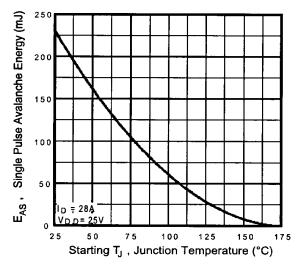


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

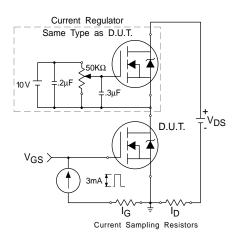


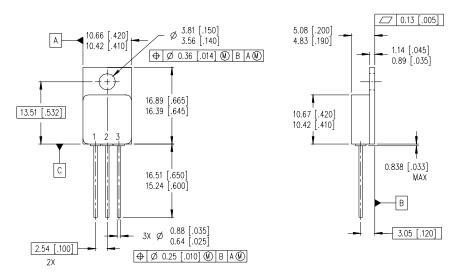
Fig 13b. Gate Charge Test Circuit

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## Footnotes:

- Repetitive Rating; Pulse width limited by maximum junction temperature.
- $\label{eq:VDD} \ensuremath{\mathbbmath${\mathbbms}$}\ensuremath{\mathbbms}$ VDD = 25V, starting TJ = 25^\circ\text{C}, L= 1.8\text{mH} \\ \ensuremath{\mathbbms}$ Peak IL = 16A, VGS = 10V \\ \ensuremath{\mathbbms}$$
- ④ Pulse width  $\leq$  300 µs; Duty Cycle  $\leq$  2%

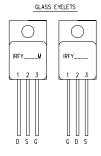
## Case Outline and Dimensions - TO-257AA



#### NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.
- D DRAIN S – SOURCE G – GATE

LEGEND



# International **ICR** Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903 Visit us at www.ifr.com for sales contact information. Data and specifications subject to change without notice. 04/01